505088546 09/11/2018

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5135304

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHU-CHUN HSIEH	08/31/2018
TSE-MIAN KUO	08/31/2018

RECEIVING PARTY DATA

Name:	Winbond Electronics Corp.	
Street Address:	No. 8, Keya 1st Rd., Daya District, Central Taiwan Science Park	
City:	Taichung City	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16124723

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	JOE MCKINNEY MUNCY
SIGNATURE:	/Joe McKinney Muncy/
DATE SIGNED:	09/11/2018

Total Attachments: 1

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PATENT 505088546 REEL: 046842 FRAME: 0200

ASSIGNMENT

WHEREAS,Chu-Chun HSIEH and Tse-Mian KUO
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:
Title: NON-VOLATILE MEMORY DEVICE AND METHOD FOR MANUFACTURING
THE SAME
Filed: Serial No
Executed on:
WHEREAS, Winbond Electronics Corp. of No. 8 Keya 1st Rd., Daya District, Central Taiwan Science Park, Taichung City,
Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring
ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;
NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.
Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.
IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.
Chu-chun Hsieh 2018/8/31
Chu-chun Hsieh Chu-chun Hsieh Date
Date
Je-20 (m. 2018/8/31 Date Date

PATENT REEL: 046842 FRAME: 0201

106-021 /0492-A45907-US